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3D-IC System Design Session

- Verification- and Extraction Solutions for 3D Stacks 30'
 Dusan Petranovic from Mentor Graphics
- A Holistic Methodology for 3D/2.5D Realization 30'
 Brandon Wang from Cadence Design Systems
- Hybrid Memory Cube 30'
 Mike Black from Micron Technology
- 3D Panel: Are we there yet? 30'

Ivo Bolsens, Xilinx

Gary Smith, Gary Smith EDA

Herb Reiter, eda2asic

Dusan Petranovic, Mentor

Brandon Wang, Cadence

Mike Black, Micron

Gene Jacubowski, E-System Design

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IC Technology and Economics

Gordon Moore's Law: 2x every 24 months **FD-SOI FinFETs** http://www.intel.com/technology/mooreslaw/ 2.5/3D -ICs ~ 50 years of Shrinking **Bulk-CMOS Planar Transistors** 1965 2030 1947 2000 2010 2020